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June 2008

NC7WZU04

TinyLogic® UHS Dual Unbuffered Inverter

Features

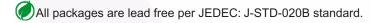
- Space saving SC70 6-lead package
- Ultra small MicroPak™ leadless package
- Unbuffered for crystal oscillator and analog applications
- Balanced output drive: ±8mA at 4.5V V_{CC}
 Broad V_{CC} operating range: 1.65V to 5.5V
- Low quiescent power: I_{CC} < 1µA at 5V V_{CC}, T_A = 25°C

General Description

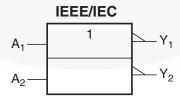
The NC7WZU04 is a dual unbuffered inverter from Fairchild's Ultra High Speed Series of TinyLogic® in the space saving SC70 6-lead package. The special purpose unbuffered circuit design is intended for crystal oscillator or analog applications. The internal circuit consists of only one-stage, the output, to allow for this part to be used in these oscillator or analog applications. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65V to 5.5V $V_{\rm CC}$ range. The inputs are high impedance when $V_{\rm CC}$ is 0V. Inputs tolerate voltages up to 7V independent of $V_{\rm CC}$ operating voltage.

Ordering Information

Order Number	Package Number	Package Code Top Mark	Package Description	Supplied As
NC7WZU04P6X	MAA06A	ZU4	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7WZU04L6X	MAC06A	B5	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

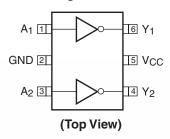


Logic Symbol

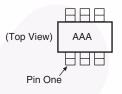


Connection Diagrams

Pin Assignment for SC70



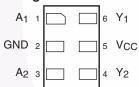
Pin One Orientation Diagram



AAA represents Product Code Top Mark – see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Through View)

Pin Descriptions

Pin Name	Description
A ₁ , A ₂	Data Inputs
Y ₁ , Y ₂	Outputs

Function Table

 $Y = \overline{A}$

Input	Output
Α	Υ
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

Absolute Maximum Ratings

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +7V
V _{IN}	DC Input Voltage	-0.5V to +7V
V _{OUT}	DC Output Voltage	-0.5V to +7V
I _{IK}	DC Input Diode Current @ V _{IN} ≤ −0.5V	-50mA
I _{OK}	DC Output Diode Current @ V _{OUT} < -0.5V V _{OUT} > 0.5V, V _{CC} = GND	–50mA +50mA
I _{OUT}	DC Output Current	±50mA
I _{CC} /I _{GND}	DC V _{CC} /GND Current	±100mA
T _{STG}	Storage Temperature	−65°C to +150°C
TJ	Junction Temperature under Bias	150°C
T _L	Junction Lead Temperature (Soldering, 10 seconds)	260°C
P _D	Power Dissipation @ +85°C SC70-6 Micropak-6	215mW 215mW

Recommended Operating Conditions⁽¹⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage Operating	1.8V to 5.5V
V _{CC}	Supply Voltage Data Retention	1.5V to 5.5V
V _{IN}	Input Voltage	0V to 5.5V
V _{OUT}	Output Voltage	0V to V _{CC}
T _A	Operating Temperature	-40°C to +85°C
θ_{JA}	Thermal Resistance	
	SC70-6	350°C/W
	Micropak-6	350°C/W

Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

				T _A =						
						+25°C	;	-40°C to	o +85°C	1
Symbol	Parameter	V _{CC} (V)	Con	ditions	Min .	Тур.	Max.	Min.	Max.	Units
V _{IH}	HIGH Level	1.8 to 2.7			0.85 V _{CC}			0.85 V _{CC}		V
	Input Voltage	3.0 to 5.5			0.8 V _{CC}			0.8 V _{CC}		
V _{IL}	LOW Level	1.8 to 2.7					0.15 V _{CC}		0.15 V _{CC}	V
	Input Voltage	3.0 to 5.5					0.2 V _{CC}		0.2 V _{CC}	
V _{OH}	HIGH Level	1.65	$V_{IN} = V_{IL}$	$I_{OH} = -100\mu A$	1.55	1.65		1.55		V
	Output Voltage	1.8			1.6	1.79		1.6		
		2.3			2.1	2.29		2.1		
		3.0			2.7	2.99		2.7		1
		4.5			4.0	4.48		4.0]
		1.65	V _{IN} = GND	I _{OH} = -2mA	1.29	1.52		1.29		V
		2.3		I _{OH} = -2mA	1.9	2.19		1.9		
		3.0		I _{OH} = -4mA	2.4	2.82		2.4		
	3.0		I _{OH} = -6mA	2.3	2.73		2.3			
		4.5		I _{OH} = -8mA	3.8	4.24		3.8		
VOL	LOW Level	1.65	$V_{IN} = V_{IH}$	I _{OL} = 100μA		0.01	0.2		0.2	V
	Output Voltage	1.8				0.01	0.2		0.2	
		2.3				0.01	0.2		0.2	
		3.0				0.01	0.3		0.3	
		4.5				0.01	0.5		0.5	
		1.65	$V_{IN} = V_{CC}$	I _{OL} = 2mA		0.10	0.24		0.24	V
		2.3		I _{OL} = 2mA		0.12	0.3		0.3	
		3.0		I _{OL} = 4mA		0.19	0.4		0.4	
		3.0		I _{OL} = 6mA		0.29	0.55		0.55	
		4.5		I _{OL} = 8mA		0.29	0.55		0.55	
I _{IN}	Input Leakage Current	0 to 5.5	$V_{IN} = 5.5V,$	GND			±0.1		±1.0	μA
I _{CC}	Quiescent Supply Current	1.65 to 5.5	$V_{IN} = 5.5V,$	GND			1.0		10	μA
I _{CCPEAK}		1.8	V _{OUT} = Ope			0.2				mA
	Current in	2.5	V _{IN} = Adjus			2				1
	Analog Operation	3.3	I _{CC} Current			5				1
		5.0				15				

AC Electrical Characteristics

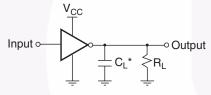
				T _A =						
					+25°C		-40°C t	o +85°C		Figure
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Number
t _{PLH} , t _{PHL}	Propagation Delay	1.65	C _L = 15pF,	1.5	5.5	9.8	1.5	11.0	ns	Figure 1
		1.8	$R_L = 1M\Omega$	1.5	4.6	8.1	1.5	8.9		Figure 3
		2.5 ± 0.2		1.2	3.3	5.7	1.2	6.3		
		3.3 ± 0.3		0.8	2.7	4.1	0.8	4.5		
		5.0 ± 0.5		0.5	2.2	3.3	0.5	3.6		
		3.3 ± 0.3	C _L = 50pF,	1.2	4.0	6.4	1.2	7.0	ns	Figure 1
		5.0 ± 0.5	$R_L = 500\Omega$,	0.8	3.4	5.6	0.8	6.2		Figure 3
C _{IN}	Input Capacitance	0			3				pF	
C _{PD}	Power Dissipation	3.3	Note 2		3.5				pF	Figure 2
	Capacitance	5.0			5.5					

Note:

2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression:

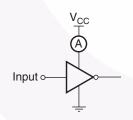
 $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC}static).$

AC Loading and Waveforms



 $^{\star}C_{L}$ includes load and stray capacitance. Input PRR = 1.0MHz; t_{W} = 500ns

Figure 1. AC Test Circuit



 $t_r = 3 \text{ns} \qquad t_f = 3 \text{ns}$ $V_{CC} \qquad 50\% \qquad 90\%$ Input $GND \qquad 10\% \qquad t_{W} \qquad 10\%$ $V_{OH} \qquad V_{OH} \qquad 50\%$ Output

Figure 3. AC Waveforms

Application Note: When operating the NC7WZU04's unbuffered output stage in its linear range, as in oscillator applications, care must be taken to observe maximum power rating for the device and package. The high drive nature of the design of the output stage will result in substantial simultaneous conduction currents when the stage is in the linear region. See the I_{CCPEAK} specification on page 2.

Input = AC Waveform; t_r , t_f = 1.8ns; PRR = 10MHz; Duty Cycle = 50%

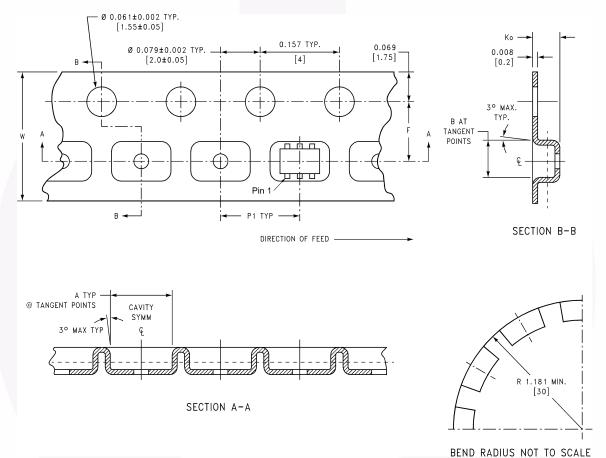
Figure 2. I_{CCD} Test Circuit

Tape and Reel Specification

Tape Format for SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status	
P6X	Leader (Start End)	125 (typ)	Empty	Sealed	
	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

Tape Dimension inches (millimeters)



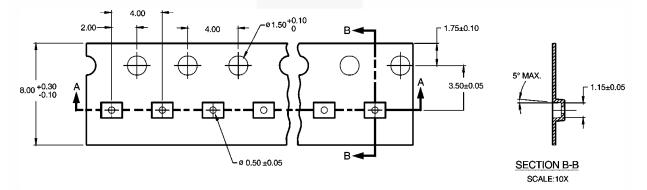
Package	Tape Size	Dim A	Dim B	Dim F	Dim K _O	Dim P1	Dim W
SC70-6	8mm	0.093	0.096		0.053 ± 0.004		0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)

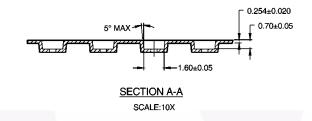
Tape and Reel Specification (Continued)

Tape Format for MicroPak

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status	
L6X	Leader (Start End)	125 (typ.)	Empty	Sealed	
	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

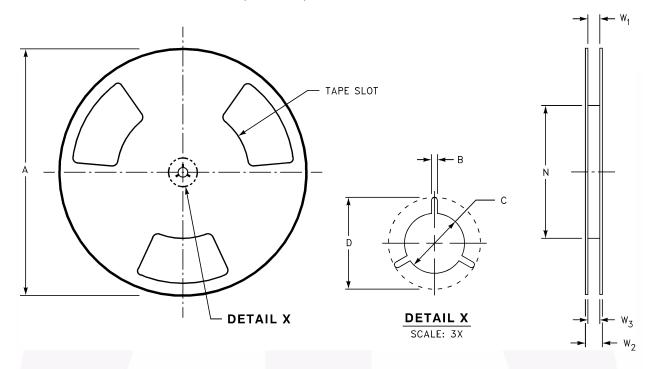
Tape Dimension inches (millimeters)





Tape and Reel Specification (Continued)

Reel Dimension for MicroPak inches (millimeters)



Tape Size	Α	В	С	D	N	W1	W2	W3
8mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

Physical Dimensions

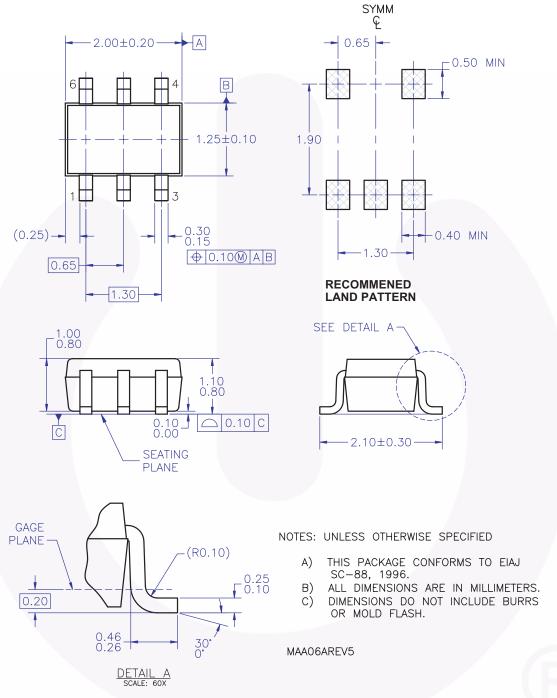
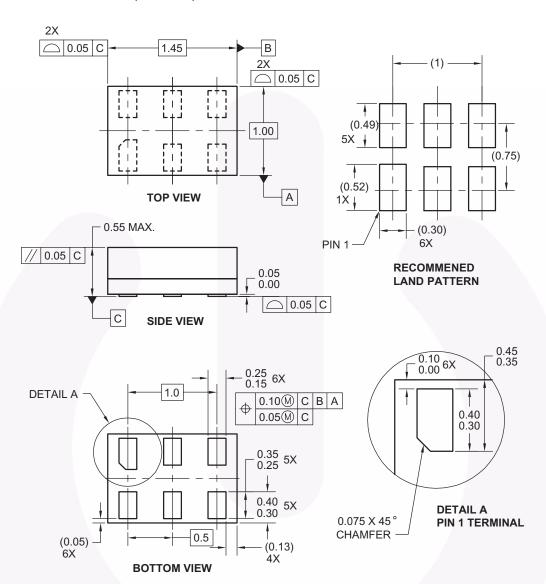


Figure 4. 6-Lead SC70, EIAJ SC88, 1.25mm Wide

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Physical Dimensions (Continued)



Notes:

- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06AREVC

Figure 5. 6-Lead MicroPak, 1.0mm Wide

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